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SPECIFICATION (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- CL05A105KP5NNNC • Samsung P/N:

- CAP, 1µF, 10V, ±10%, X5R, 0402 • Description :

A. Samsung Part Number

		<u>CL</u>	<u>05</u>	<u>A</u>	<u>105</u>	<u>K</u>	<u>P</u>	<u>5</u>	<u>N</u>	N	<u>N</u>	<u>C</u>
		1	2	3	4	(5)	6		8	9	10	1
1	Series	Samsung Multi-layer Ceramic Capacitor										
2	Size	0402 (inch c	ode)		L:	1.0	± 0.0	5	mm		W:	$0.5 \pm 0.05 \text{ mm}$
3	Dielectric	X5R				8	Inner	· elec	ctrod	e		Ni
4	Capacitance	1 µF					Term	inati	ion			Cu
5	Capacitance	±10 %					Plati	ng				Sn 100% (Pb Free)
	tolerance					9	Prod	uct				Normal
6	Rated Voltage	10 V				10	Spec	ial				Reserved for future use
\bigcirc	Thickness	0.5 ± 0.05	mm			1	Pack	agin	g			Cardboard Type, 7" reel

B. Samsung Reliability Test and Judgement condition

	Judgement	Test condition					
Capacitance	Within specified tolerance	1ktz±10% 1.0±0.2Vrms					
Tan δ (DF)	0.1 max.						
Insulation	10,000Mohm or 100Mohm·μF	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Microscope (×10)					
Withstanding	No dielectric breakdown or	250% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	X5R						
Characteristics	(From -55 ℃ to 85 ℃, Capacitance change should be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)					
		with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120℃ for 10~30sec.)					
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	Tan δ, IR : initial spec.						

	Judgement	Test condition				
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm				
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)				
		2hours × 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance	Tan δ 0.2 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	IR : $12.5M\Omega \cdot \mu F$ or Over					
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage				
Resistance	Tan δ 0.2 max	Max. operating temperature				
	IR : 25№· <i>μ</i> F or Over	1000+48/-0hrs				
Temperature	Capacitance change : within ±7.5%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25 °C				
		\rightarrow Max. operating temperature \rightarrow 25 °C				
		5 cycle test				

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^\circ\!\!{\rm C}$, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.